<u>MOSFET</u> – Power, Dual, N-Channel, TSOP-6

20 V, 3.5 A

Features

- Low Threshold Levels, VGS(th) < 1.5 V
- Low Gate Charge (3.8 nC)
- Leading Edge Trench Technology of Low R_{DS(on)}
- High Power and Current Handling Capability
- This is a Pb–Free Device

Applications

- DC-DC Converters (Buck and Boost Circuits)
- Low Side Load Switch
- Optimized for Battery and Load Management Applications in Portable Equipment Like Cell Phones, DSCs, Media Player, Etc
- Battery Charging and Protection Circuits

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

1					
Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V _{DSS}	20	V
Gate-to-Source Voltage			V _{GS}	±12	V
Continuous Drain	Steady State	$T_A = 25^{\circ}C$	I _D	3.0	А
Current (Note 1)		$T_A = 85^{\circ}C$		2.2	
Continuous Drain Current (Note 1)	t≤5s	$T_A = 25^{\circ}C$	۱ _D	3.5	A
Power Dissipation (Note 1)	Steady State	$T_A = 25^{\circ}C$	PD	0.9	W
	t≤5 s			1.1	
Pulsed Drain Curre	Pulsed Drain Current $t_p = 10 \ \mu s$		I _{DM}	10	А
Operating Junction and Storage Temperature		T _J , T _{STG}	–50 to 150	°C	
Source Current (Body Diode)			۱ _S	0.8	А
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{\theta JA}$	140	°C/W
Junction-to-Ambient – t \leq 5 s (Note 1)	$R_{\theta JA}$	110	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface Mounted on FR4 Board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).

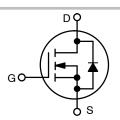


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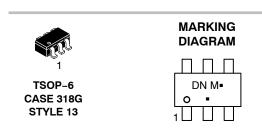
http://onsemi.com

N-CHANNEL MOSFET

V _{(BR)DSS}	R _{DS(on)} Max	I _D Max
20 V	70 mΩ @ 4.5 V	3.5 A
20 V	100 mΩ @ 2.5 V	0.0 A



N-CHANNEL MOSFET

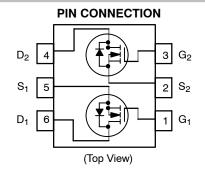


DN = Specific Device Code

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

MOSFET ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise noted)

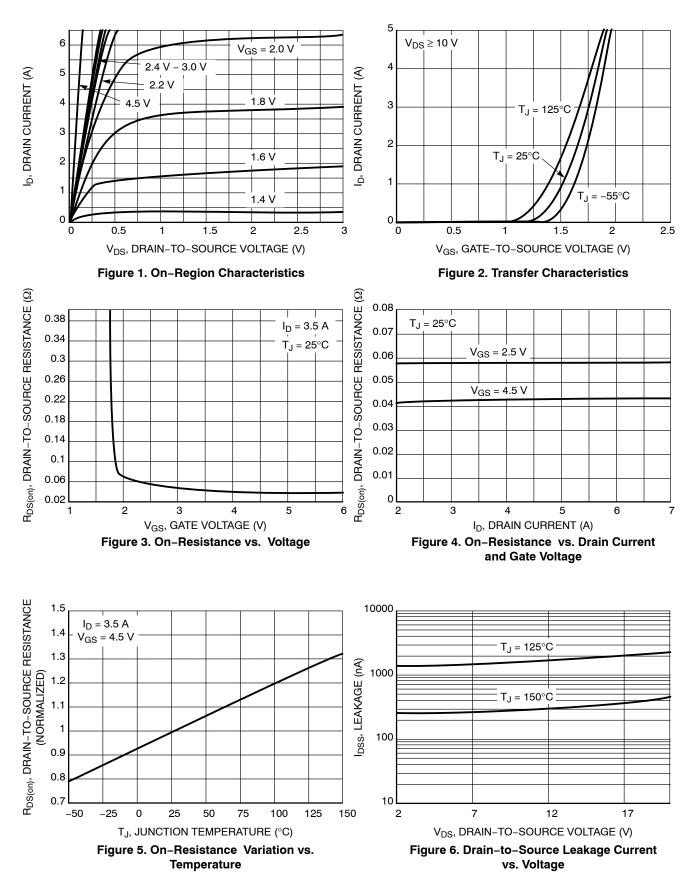
Characteristic	Symbol	Test Cor	ndition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _I	_D = 250 μA	20			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	I _D = 250 μA, Ref to 25°C			12.5		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 16 V	T _J = 25°C T _J = 125°C			1.0 10	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V	, e			100	nA
ON CHARACTERISTICS (Note 2)	466		40				
Gate Threshold Voltage	V _{GS(TH)}	V _{GS} = V _{DS} , I	р = 250 µA	0.5		1.5	V
Gate Threshold Temperature Coefficient	V _{GS(TH)} /T _J	- 63 - 53, -	0		3.28		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 3.5 A		41.7	70	,
	20(01)	V _{GS} = 2.5 V	I _D = 2.8 A		58	100	mΩ
Forward Transconductance	9 FS	V _{DS} = 5.0 V,	I _D = 3.5 A		6.2		S
CHARGES, CAPACITANCES AND GATE F	RESISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V			300		
Output Capacitance	C _{OSS}				73		pF
Reverse Transfer Capacitance	C _{RSS}				44		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 4.5 V, V_{DS} = 10 V, I_{D} = 3.5 A			3.8		nC
Threshold Gate Charge	Q _{G(TH)}				0.3		
Gate-to-Source Charge	Q _{GS}				0.7		
Gate-to-Drain Charge	Q _{GD}				1.1		
Gate Resistance	RG				2.8		Ω
SWITCHING CHARACTERISTICS (Note 3)							
Turn-On Delay Time	t _{d(ON)}				7.4		
Rise Time	t _r	V _{GS} = 4.5 V, V	V _{DS} = 10 V,		11.2		1
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 3.5 \text{ A}, \text{ R}_G = 3.0 \Omega$			12.8		ns
Fall Time	t _f				1.6		
DRAIN-TO-SOURCE CHARACTERISTICS	<u> </u>						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V	$T_J = 25^{\circ}C$		0.71		
		I _D = 0.8 A	T _J = 125°C		0.57		- V
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, d_{IS}/d_t = 100 A/µs, I_S = 0.8 A			9.0		
Charge Time	Ta				5.0		ns
Discharge Time	T _b				4.0		1
Reverse Recovery Time	Q _{RR}				2.5		nC

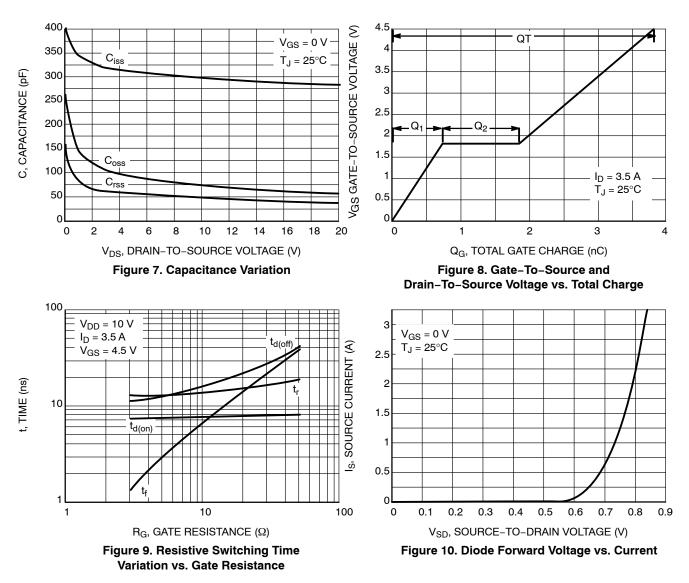
3. Switching characteristics are independent of operating junction temperatures.

ORDERING INFORMATION

Device	Package	Shipping [†]
NTGD3148NT1G	TSOP–6 (Pb–Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.









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